

Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Suggested Classification::	
Suggested Group Art Unit::	
CD-ROM or CD_R?::	None
Number of CD disks::	
Number of copies of CDs::	
Sequence Submission::	No
Computer Readable Form (CRF)?::	No
Title::	LEAD FRAME, RESIN-ENCAPSULATED SEMICONDUCTOR DEVICE, AND METHOD OF PRODUCING THE SAME
Attorney Docket Number::	10873.1294US01
Request For Early Publication::	No
Request For Non-Publication::	No
Suggested Drawing Figure::	1A and 1B
Total Drawing Sheets::	8
Small Entity::	No
Latin Name::	
Variety Denomination Name::	
Petition Included::	No
Petition Type::	
Licensed US Govt. Agency::	
Contract or Grant Numbers::	
Secrecy Order in Parent Appl.?::	No

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Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Masanori
Middle Name::
Family Name:: MINAMIO
Name Suffix::
City of Residence:: Takatsuki-shi
State or Province of Residence::
Country of Residence:: Japan
Street of mailing address:: 2-10-7, Utsukushigaoka
City of mailing address:: Takatsuki-shi
State or Province of mailing address:: Osaka
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 569-1111

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Haruto
Middle Name::
Family Name:: NAGATA
Name Suffix::
City of Residence:: Sakai-shi
State or Province of Residence::
Country of Residence:: Japan
Street of mailing address:: 5-1-14 Higashimikunigaoka-cho

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City of mailing address:: Sakai-shi
State or Province of mailing address:: Osaka
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 591-8046

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Tetsushi
Middle Name::
Family Name:: NISHIO
Name Suffix::
City of Residence:: Kyoto-shi
State or Province of Residence::
Country of Residence:: Japan
Street of mailing address:: 10-205, Koudan Fushiminoushodanchi,
Noushoshimono 1, Fushimi-ku
City of mailing address:: Kyoto-shi
State or Province of mailing address:: Kyoto
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 612-8267

Correspondence Information

Correspondence Customer Number:: 23552

Representative Information

Representative Customer Number::	23552
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Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2002-254369	08/30/02	Yes

Assignee Information

Assignee Name:: Matsushita Electric Industrial Co., Ltd.
Street of mailing address:: 1006, Oaza Kadoma
City of mailing address:: Kadoma-shi
State or Province of mailing address:: Osaka
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 571-8501